

BWIR-35C1R15

Features:

1. Input power: 1W.

2. Chip material: AlGaAs.

3. Emitted color: Red.

4. High lumen output.

5. High flux density.

6. Low power consumption.

7. Efficient heat transfer.

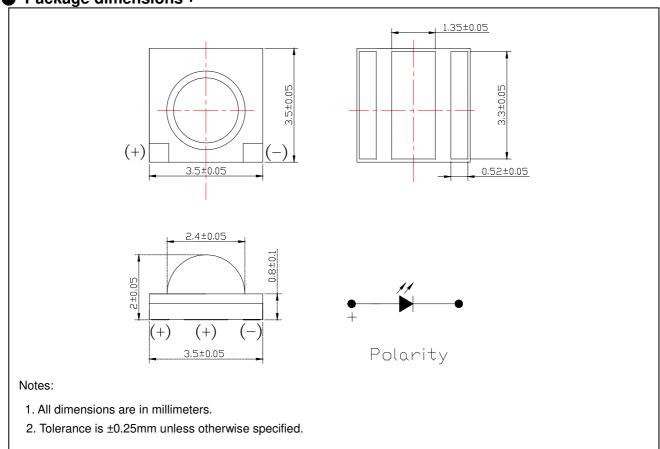
8. Exterior lens is silicone.

9. Add extra heat sink is necessary.

Applications:

- 1. Torch.
- 2. Head Light.
- 3. Architectural Lighting.
- 4. LCD Backlight.

Package dimensions :





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■ Absolute maximum ratings (T_a=25°C)

Parameter	Symbol	Rating	Unit
Power Dissipation	P _D	1.0	W
DC Forward Current	I _F	350	mA
Peak Pulsed Forward Current*	I _{FP}	1.0	А
LED Junction Temperature	TJ	115	°C
Operating Temperature	Topr	-40~ +85	°C
Storage Temperature	Tstg	-40~ +100	°C
Reverse Voltage	V _R	5	V
Manual Soldering (T=5 sec)	Tsol	350 ± 5	°C

^{*}Condition for I_{FP} is pulsed with 1/10 duty and 0.1msec width.

● Electrical & Optical Characteristics (T_a=25°C)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	V _F	I _F =350mA	1.8	-	2.6	V
Total Flux	Ф	I _F =350mA	-	50	-	lm
Peak Wavelength	λр	I _F =350mA	-	630	-	nm
Dominant Wavelength	λd	I _F =350mA	615	-	630	nm
Spectral Line Half-width	Δλ	I _F =350mA	-	25	-	nm
Reverse Current	I _R	V _R =5V	-	-	5	μΑ
Thermal Resistance, Junction To Case	R heta J-C	I _F =350mA	-	9	-	°C/W
Viewing Angle	2θ _{1/2}	I _F =350mA	-	120	-	degree

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Typical electro-optical characteristics curves

Fig.1 RELATIVE INTENSITY VS. WAVELENGTH

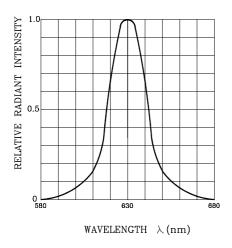


Fig.3 FORWARD CURRENT VS. FORWARD VOLTAGE

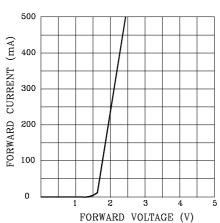


Fig.5 RELATIVE LUMINOUS INTENSITY
VS. FORWARD CURRENT

(at Ta=25°C)

1.5

0.2

0.4

0.6

FORWARD CURRENT

(A)

Fig.2 FORWARD CURRENT VS. AMBIENT TEMPERATURE

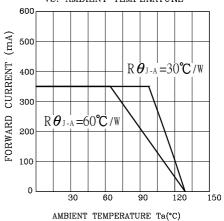


Fig.4 RELATIVE LUMINOUS INTENSITY VS. JUNCTION TEMPERATURE

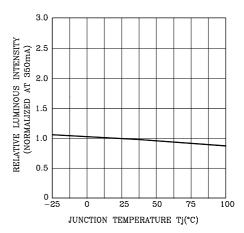
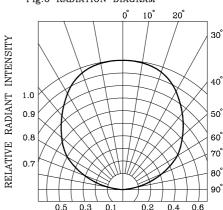


Fig.6 RADIATION DIAGRAM





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●Total Flux Bin Limits (At 350mA)

BIN CODE	Min. (lm)	Max. (lm)		
М	42	55		
N	55	72		

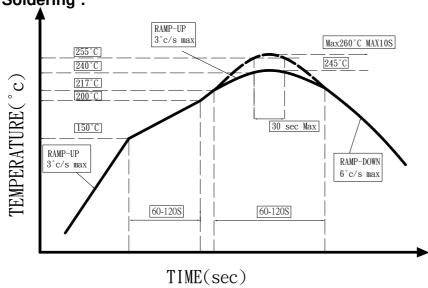
Tolerance for each Bin limit is ± 15 %



Notes:

1. Bin categories are established for classification of products. Products may not be available in all bin categories.







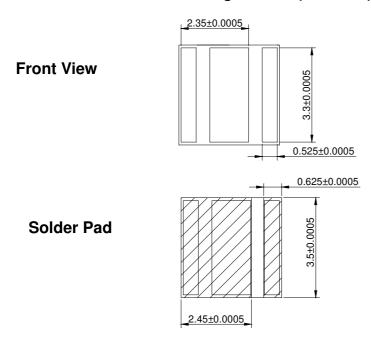
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- 1. Avoid any external stress applied to the resin while the LEDs are at high temperature, especially during soldering.
- 2. Avoid rapid cooling or any excess vibration during temperature ramp-down process
- Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs

IRON Soldering

350°C Within 3 sec,one time only.

Recommended Soldering Pattern (Unit:mm)



Handling:

Care must be taken not to damage LED's silicone while exposing to high temperature or contact LED's silicone with hard or sharp objects, such as metal hook, tweezer or sand blasting.



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Notes for designing:

Current limiting resistor or a constant current power supply must be used in the circuit to drive BRIGHT LEDs within the rated figures and not to overload BRIGHT LEDs with instantaneous voltage at the turning ON and OFF cycles.

When using pulse driving, the average current must be within the rated figures. And the circuit should be designed to avoid reverse voltage when turning off the BRIGHT LEDs.

Storage:

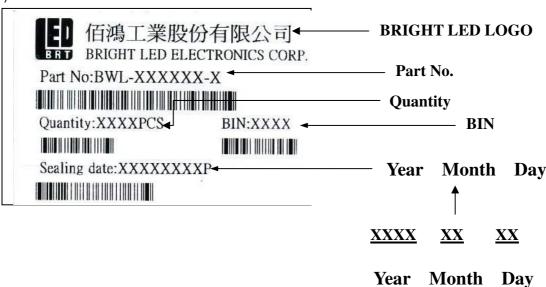
In order to avoid the absorption of moisture, it is recommended to solder BRIGHT LEDs as soon as possible after unpacking the sealed envelope.

If the envelope is still packed, to store it in the environment as following:

- (1) Temperature : 5° C 30° C (41° F) Humidity : RH 60% Max.
- (2) After this bag is opened, devices that will be applied to infrared reflow, vapor-phase reflow, or equivalent soldering process must be:
- a. Completed within 24 hours.
- b. Stored at less than 30% RH.
- (3) Devices require baking before mounting, if:
 - (2) a or (2) b is not met.
- (4) If baking is required, devices must be baked under below conditions: 48 hours at $60^{\circ}\text{C} \pm 3^{\circ}\text{C}$.

Package and Label of Products:

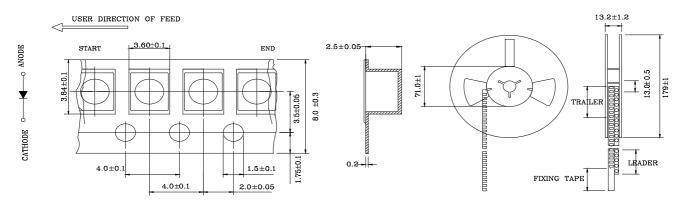
- (1) Package: Products are packed in one bag of 800 pcs (one taping reel) and a label is attached to each bag.
- (2) Label:





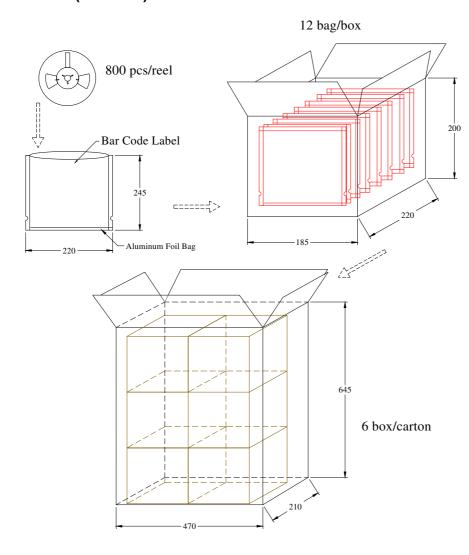
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Tapping and packaging specifications (Units: mm)



NOTE:1000 PCS PER REEL

Package Method (unit:mm)



NOTES : Bag : Tolerance is $\pm\,5$ mm unless otherwise noted.

Carton: Tolerance is ± 10 mm unless otherwise noted.